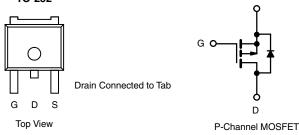


Vishay Siliconix

Automotive P-Channel 80 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	- 80			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -10 V$	0.025			
$R_{DS(on)}(\Omega)$ at V_{GS} = - 4.5 V	0.031			
I _D (A)	- 50			
Configuration	Single			

TO-252



FEATURES

- TrenchFET[®] Power MOSFET
- AEC-Q101 Qualified^d
- 100 % $R_{\rm q}$ and UIS Tested
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>



ORDERING INFORMATION	
Package	TO-252
Lead (Pb)-free and Halogen-free	SQD50P08-25L-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	- 80	V	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current	$T_C = 25 \ ^\circ C^a$	- I _D	- 50		
	T _C = 125 °C		- 28		
Continuous Source Current (Diode Conduction) ^a		I _S	- 50	А	
Pulsed Drain Current ^b		I _{DM}	- 120		
Single Pulse Avalanche Current	– L = 0.1 mH	I _{AS}	- 45		
Single Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	100	mJ	
Mauianan Davia Diasia atianh	T _C = 25 °C	PD	136	w	
Maximum Power Dissipation ^b	T _C = 125 °C	' D	45	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	C°	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	50	°C/W
Junction-to-Case (Drain)		R _{thJC}	1.1	C/W

Notes

a. Package limited.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. When mounted on 1" square PCB (FR-4 material).

d. Parametric verification ongoing.

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static						•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$		- 80	-	-	v	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$		- 2.0	- 2.5	V	
Gate-Source Leakage	I _{GSS}	V _{DS} =	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	± 100	nA	
		$V_{GS} = 0 V$	V _{DS} = - 80 V	-	-	- 1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	V_{DS} = - 80 V, T_J = 125 °C	-	-	- 50	μA	
		$V_{GS} = 0 V$	V_{DS} = - 80 V, T_{J} = 175 °C	-	-	- 250	1	
On-State Drain Current ^a	I _{D(on)}	$V_{GS} = -10 V$	$V_{DS} \le$ - 5 V	- 50	-	-	А	
		$V_{GS} = -10 V$	I _D = - 12.5 A	-	0.020	0.025	Ω	
Drain Source On State Resistence	В	$V_{GS} = - 10 V$	I _D = - 12.5 A, T _J = 125 °C	-	-	0.044		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -10 V$	I _D = - 12.5 A, T _J = 175 °C	-	-	0.055		
		$V_{GS} = -4.5 V$	I _D = - 10.5 A	-	0.025	0.031		
Forward Transconductanceb	9 _{fs}	V _{DS} = -	V _{DS} = - 15 V, I _D = - 12.5 A		38	-	S	
Dynamic ^b		-						
Input Capacitance	C _{iss}		V _{DS} = - 25 V, f = 1 MHz	-	4279	5350	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	356	445		
Reverse Transfer Capacitance	C _{rss}			-	239	300		
Total Gate Charge ^c	Qg			-	91	137		
Gate-Source Charge ^c	Q _{gs}	V _{GS} = - 10 V	V_{DS} = - 40 V, I_D = - 12.5 A	-	8.2	-	nC	
Gate-Drain Charge ^c	Q _{gd}			-	24	-		
Gate Resistance	Rg	f = 1 MHz		1.60	3.26	5.00	Ω	
Turn-On Delay Time ^c	t _{d(on)}			-	10	15		
Rise Time ^c	t _r	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = \text{-} \; 40 \; \text{V}, \; R_{\text{L}} = 3.2 \; \Omega \\ I_{\text{D}} \cong \text{-} \; 12.5 \; \text{A}, \; V_{\text{GEN}} = \text{-} \; 10 \; \text{V}, \; R_{\text{g}} = 1 \; \Omega \end{array}$		-	11	17	ns	
Turn-Off Delay Time ^c	t _{d(off)}			-	71	107		
Fall Time ^c	t _f			-	16	24		
Source-Drain Diode Ratings and Char	acteristics ^b							
Pulsed Current ^a	I _{SM}			-	-	- 120	Α	
Forward Voltage	V _{SD}	I _F = - 10.5 A, V _{GS} = 0 V		-	- 0.82	- 1.5	V	

Notes

a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

b. Guaranteed by design, not subject to production testing.

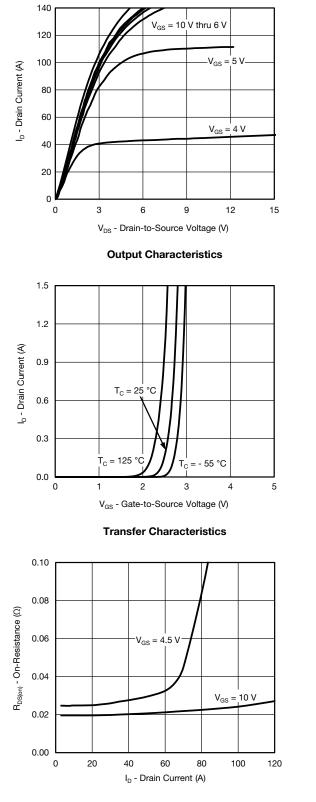
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

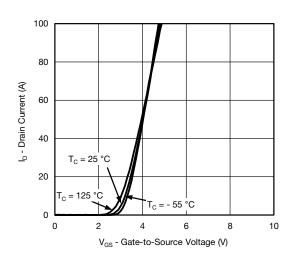


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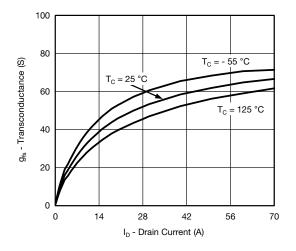
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



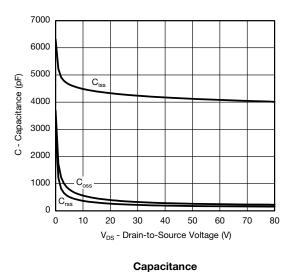
On-Resistance vs. Drain Current



Transfer Characteristics



Transconductance



S12-1846-Rev. B, 30-Jul-12

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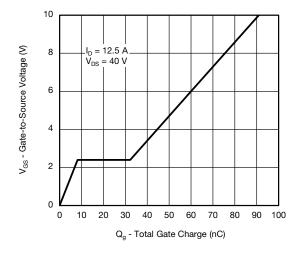
Document Number: 72217

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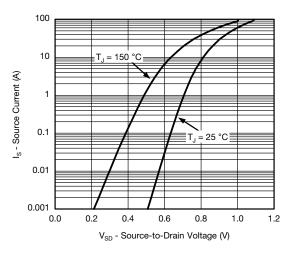


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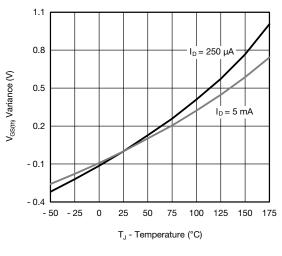
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



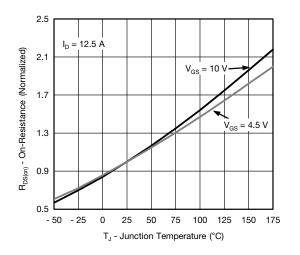




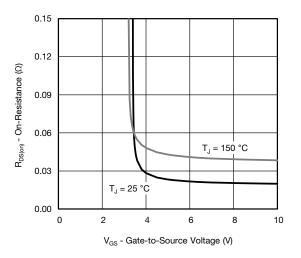
Source Drain Diode Forward Voltage



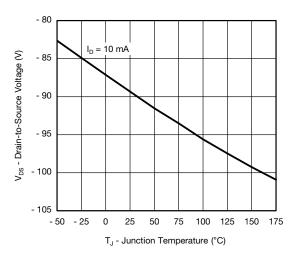
Threshold Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature

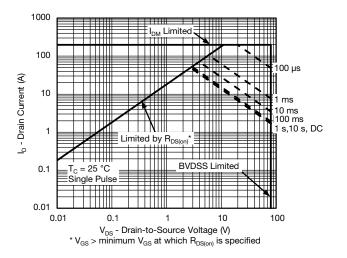
S12-1846-Rev. B, 30-Jul-12

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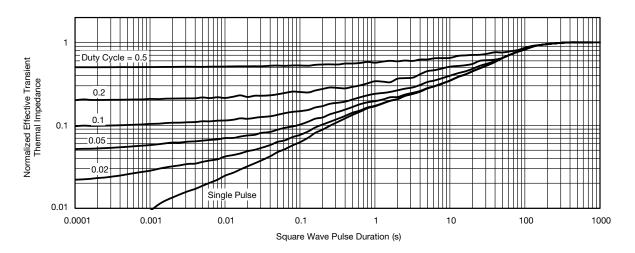


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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Safe Operating Area



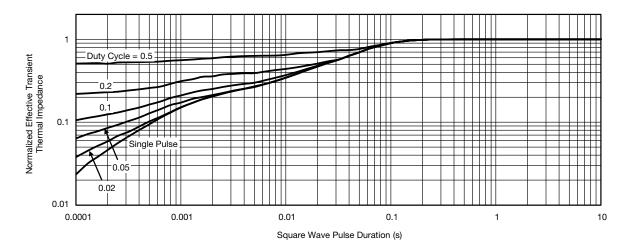
Normalized Thermal Transient Impedance, Junction-to-Ambient

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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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Е b3 Ľ Δ ŝ b2 e1 Б E1

C2 т gage plane height (0.5 mm)

-C

- A1

TO-252AA Case Outline

	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	2.28 BSC 0.090 BSC			
e1	4.56	4.56 BSC		0.180 BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T13-0592-Rev. A, 02-Sep-13 DWG: 6019					

Note

• Dimension L3 is for reference only.





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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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